



**US1A - US1M** 

## 1.0A SURFACE MOUNT ULTRA-FAST RECTIFIER

### **Features**

- Glass Passivated Die Construction
- Ultra-Fast Recovery Time for High Efficiency
- Surge Overload Rating to 30A Peak
- High Current Capability
- Ideally Suited for Automated Assembly
- Lead-Free Finish; RoHS Compliant (Note 1)
- Halogen and Antimony Free. "Green" Device (Note 2)

## **Mechanical Data**

- Case: SMA
- Case Material: Molded Plastic. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Lead Free Plating (Matte Tin Finish). Solderable per MIL-STD-202, Method 208 63
- Polarity: Cathode Band or Cathode Notch
- Weight: 0.064 grams (Approximate)





Top View

Bottom viev

# Ordering Information (Note 3)

Part Number*	Case	Packaging
US1x-13-F	SMA	5,000/Tape & Reel

\*x = Device type, e.g. US1A-13-F.

Notes:

- 1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. All applicable RoHS exemptions applied.
- 2. See http://www.diodes.com/quality/lead\_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

## **Marking Information**



US1x = Product Type Marking Code, ex: US1A

OH = Manufacturers' Code Marking

YWW = Date Code Marking

Y = Last Digit of Year (ex: 4 for 2014)

WW = Week Code (01 to 53)



## **Maximum Ratings** (@T<sub>A</sub> = +25°C unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load. For capacitance load, derate current by 20%.

Characteristic	Symbol	US1A	US1B	US1D	US1G	US1J	US1K	US1M	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage (Note 4)	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	50	100	200	400	600	800	1000	٧
RMS Reverse Voltage	V <sub>R(RMS)</sub>	35	70	140	280	420	560	700	V
Average Rectified Output Current @ $T_T = +75$ °C	lo				1.0				Α
Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load	I <sub>FSM</sub>				30				Α

## **Thermal Characteristics**

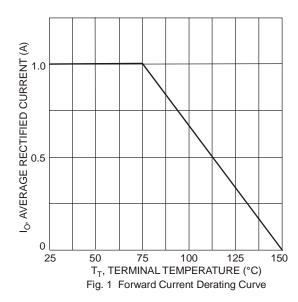
Characteristic	Symbol	Value	Unit
Maximum Thermal Resistance, Junction to Terminal	$R_{\theta JT}$	30	°C/W
Operating and Storage Temperature Range	$T_{J_i}T_{STG}$	-65 to +150	°C

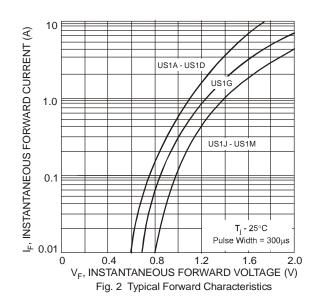
# **Electrical Characteristics** ( $@T_A = +25$ °C unless otherwise specified.)

Characteristic		Symbol	US1A	US1B	US1D	US1G	US1J	US1K	US1M	Unit
Forward Voltage Drop	@ I <sub>F</sub> = 1.0A	$V_{FM}$		1.0		1.3		1.7		V
Peak Reverse Current	@ T <sub>A</sub> = +25°C	I	5.0					μΑ		
at Rated DC Blocking Voltage (Note 4)	@ $T_A = +100^{\circ}C$	IRM	100							
Reverse Recovery Time (Note 5)		t <sub>rr</sub>		5	50			75		ns
Typical Total Capacitance (Note 6)		C <sub>T</sub>		2	20			10		pF

Notes:

- 4. Short duration pulse test used to minimize self-heating effect.
- 5. Measured with  $I_F$  = 0.5A,  $I_R$  = 1.0A,  $I_{rr}$  = 0.25A. See Figure 5. 6. Measured at 1.0MHz and applied reverse voltage of 4.0V DC.







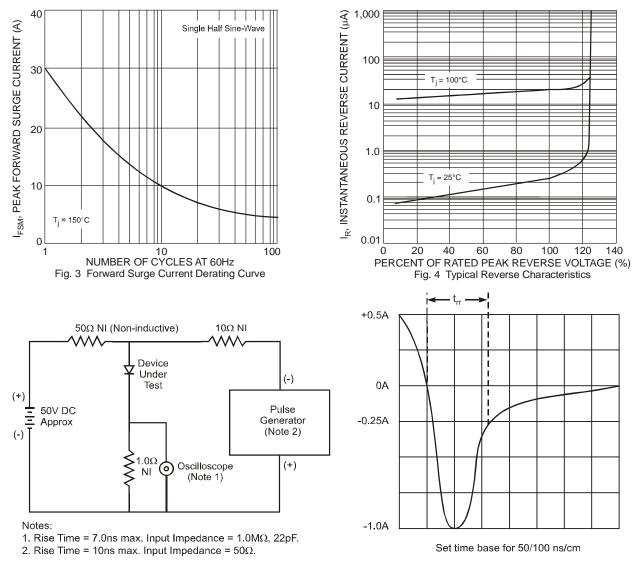
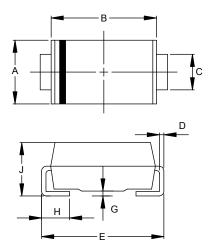


Fig. 5 Reverse Recovery Time Characteristic and Test Circuit



## **Package Outline Dimensions**

Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for latest version.

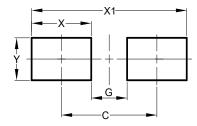


SMA							
Dim	Min	Max					
Α	2.29	2.92					
В	4.00	4.60					
C	1.27	1.63					
D	0.15	0.31					
Е	4.80	5.59					
G	0.05	0.20					
H	1.52						
<b>J</b> 1.96 2.40							
All Dimensions in mm							

# **Suggested Pad Layout**

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for latest version.

## SMA



Dimensions	value				
Difficusions	(in mm)				
С	4.00				
G	1.50				
Χ	2.50				
X1	6.50				
Υ	1.70				



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